

N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA1855 is a switching device which can be driven directly by a 2.5 V power source.

The μ PA1855 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- Can be driven by a 2.5 V power source
- · Low on-state resistance $R_{DS(on)1} = 23 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, \text{ ID} = 3.0 \text{ A})$ $R_{DS(on)2} = 24 \text{ m}\Omega \text{ MAX.}$ (Vgs = 4.0 V, ID = 3.0 A) $R_{DS(on)3} = 29 \text{ m}\Omega \text{ MAX.}$ (Vgs = 2.5 V, ID = 3.0 A)
- Built-in G-S protection diode against ESD

ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1855GR-9JG	Power TSSOP8

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Drain to Source Voltage	Vdss	20
Gate to Source Voltage	Vgss	±12
Drain Current (DC)	ID(DC)	±6.0
Drain Current (pulse) Note1	D(pulse)	±24
Total Power Dissipation Note2	P⊤	2.0
Channel Temperature	Tch	150
Storage Temperature	Tstg	–55 to +150

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

2. Mounted on ceramic substrate of 5000 mm² x 1.1 mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

V

V

A

Α

W

°C °C

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Document No. D13454EJ2V0DS00 (2nd edition) May 2001 NS CP(K) Date Published Printed in Japan

3.15 ±0.15 3.0 ±0.1

0.65

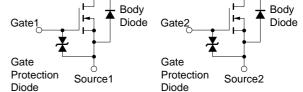
Drain2

6.4 ±0.2

 4.4 ± 0.1

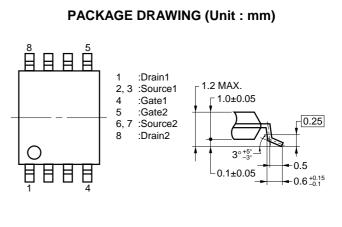
1.0 ±0.2

□ 0.1



EQUIVALENT CIRCUIT

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 45 ± 0.055

Drain1

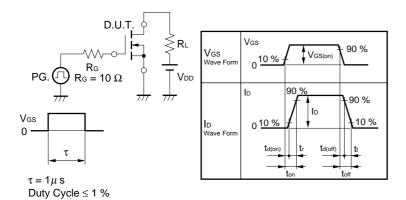
Q

0.8 MAX. 0.27+0.03 0.10 M

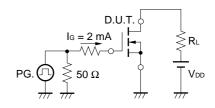
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-off Current	IDSS	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 12 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	$V_{DS} = 10 V, I_{D} = 1 mA$	0.5	1.0	1.5	V
Forward Transfer Admittance	y _{fs}	$V_{DS} = 10 V, I_D = 3.0 A$	1	13.3		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = 4.5 \text{ V}, \text{ Id} = 3.0 \text{ A}$		17	23	mΩ
	RDS(on)2	$V_{GS} = 4.0 V, I_{D} = 3.0 A$		18	24	mΩ
	RDS(on)3	Vgs = 2.5 V, Id = 3.0 A		22	29	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		980		pF
Output Capacitance	Coss	Vgs = 0 V		293		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		205		pF
Turn-on Delay Time	td(on)	V _{DD} = 10 V		86		ns
Rise Time	tr	ID = 3.0 A		247		ns
Turn-off Delay Time	td(off)	$V_{GS(on)} = 4.0 V$		480		ns
Fall Time	tr	$R_G = 10 \Omega$		659		ns
Total Gate Charge	Q _G	Vdd = 10 V		8.8		nC
Gate to Source Charge	QGS	ID = 6.0 A		2.2		nC
Gate to Drain Charge	Qgd	Vgs = 4.0 V		3.2		nC
Diode Forward Voltage	VF(S-D)	IF = 6.0 A, VGS = 0 V		0.82		V
Reverse Recovery Time	trr	IF = 6.0 A, VGS = 0 V		44		ns
Reverse Recovery Charge	Qrr	di/dt = 15 A/ μ s		2.2		nC

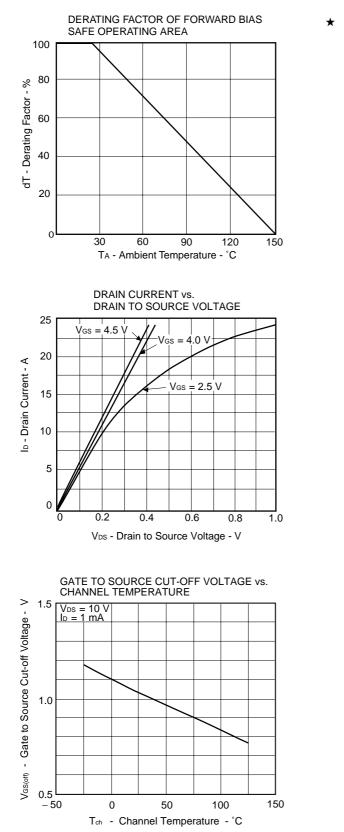
TEST CIRCUIT 1 SWITCHING TIME

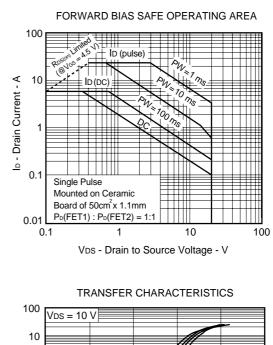


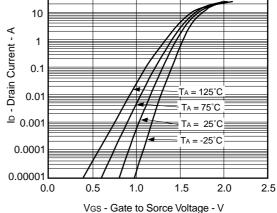
TEST CIRCUIT 2 GATE CHARGE



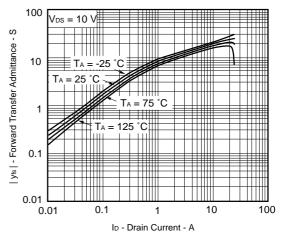


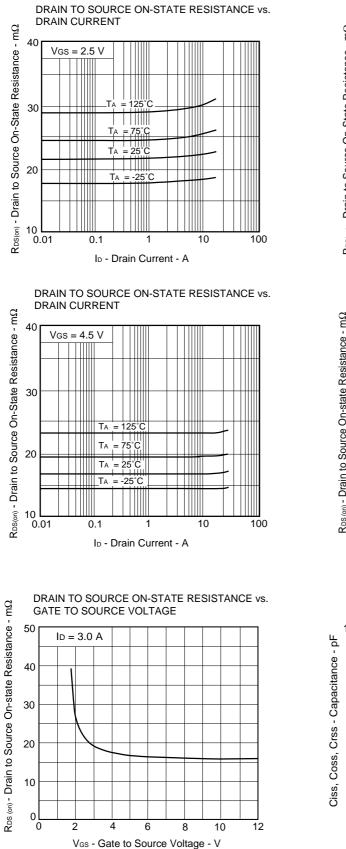




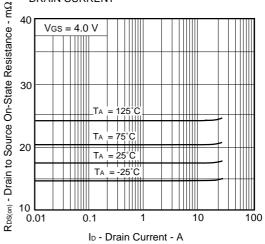


FORWARD TRANSFER ADMITTANCE Vs. DRAIN CURRENT

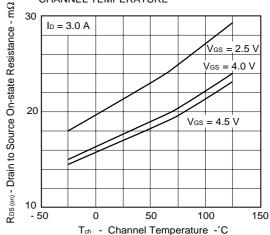


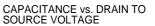


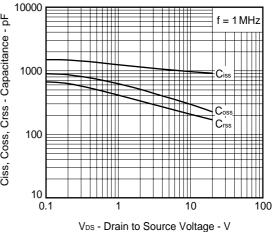
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

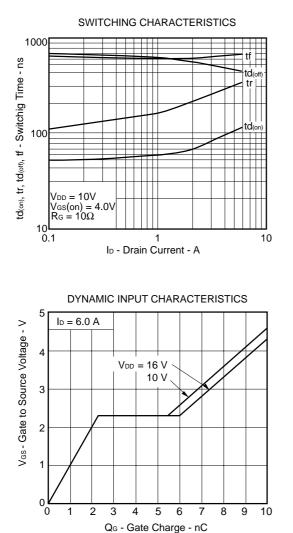


DRAIN TO SOURCE ON STATE RESISTANCE vs. CHANNEL TEMPERATURE

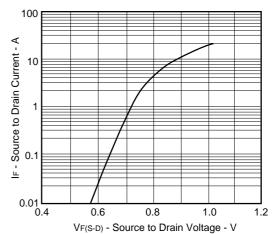


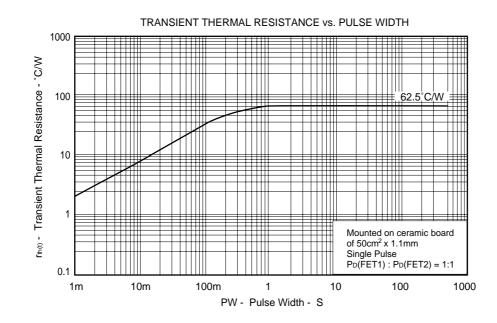






SOURCE TO DRAIN DIODE FORWARD VOLTAGE





Data Sheet D13454EJ2V0DS

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